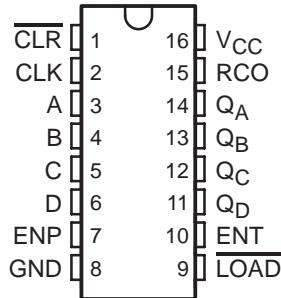


- 2-V to 5.5-V  $V_{CC}$  Operation
- Max  $t_{pd}$  of 9.5 ns at 5 V
- Typical  $V_{OLP}$  (Output Ground Bounce)  
<0.8 V at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  
>2.3 V at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C
- Support Mixed-Mode Voltage Operation on All Ports
- Internal Look-Ahead for Fast Counting
- Carry Output for n-Bit Cascading
- Synchronous Counting
- Synchronously Programmable
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

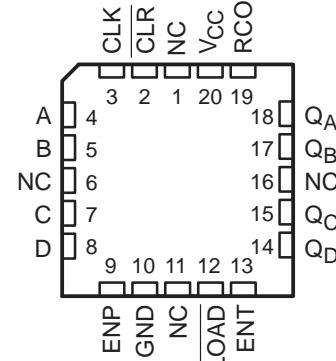
#### description/ordering information

The 'LV161A devices are 4-bit synchronous binary counters designed for 2-V to 5.5-V  $V_{CC}$  operation.

SN54LV161A . . . J OR W PACKAGE  
SN74LV161A . . . D, DB, DGV, NS, OR PW PACKAGE  
(TOP VIEW)



SN54LV161A . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

#### ORDERING INFORMATION

$T_A$	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
$-40^{\circ}\text{C}$ to $85^{\circ}\text{C}$	SOIC – D	Tube of 40	SN74LV161AD	LV161A
		Reel of 2500	SN74LV161ADR	
	SOP – NS	Reel of 2000	SN74LV161ANSR	74LV161A
	SSOP – DB	Reel of 2000	SN74LV161ADBR	LV161A
	TSSOP – PW	Tube of 90	SN74LV161APW	LV161A
		Reel of 2000	SN74LV161APWR	
		Reel of 250	SN74LV161APWT	
$-55^{\circ}\text{C}$ to $125^{\circ}\text{C}$	TVSOP – DGV	Reel of 2000	SN74LV161ADGVR	LV161A
	CDIP – J	Tube of 25	SNJ54LV161AJ	SNJ54LV161AJ
	CFP – W	Tube of 150	SNJ54LV161AW	SNJ54LV161AW
	LCCC – FK	Tube of 55	SNJ54LV161AFK	SNJ54LV161AFK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

# SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

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## description/ordering information (continued)

These synchronous, presettable counters feature an internal carry look-ahead for application in high-speed counting designs. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the count-enable (ENP, ENT) inputs and internal gating. This mode of operation eliminates the output counting spikes that normally are associated with synchronous (ripple-clock) counters. A buffered clock (CLK) input triggers the four flip-flops on the rising (positive-going) edge of the clock waveform.

These counters are fully programmable; that is, they can be preset to any number between 0 and 9 or 15. As presetting is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the setup data after the next clock pulse, regardless of the levels of the enable inputs.

The clear function for the 'LV161A devices is asynchronous. A low level at the clear (CLR) input sets all four of the flip-flop outputs low, regardless of the levels of the CLK, load (LOAD), or enable inputs.

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are ENP, ENT, and a ripple-carry output (RCO). Both ENP and ENT must be high to count, and ENT is fed forward to enable RCO. Enabling RCO produces a high-level pulse while the count is maximum (9 or 15 with  $Q_A$  high). This high-level overflow ripple-carry pulse can be used to enable successive cascaded stages. Transitions at ENP or ENT are allowed, regardless of the level of CLK.

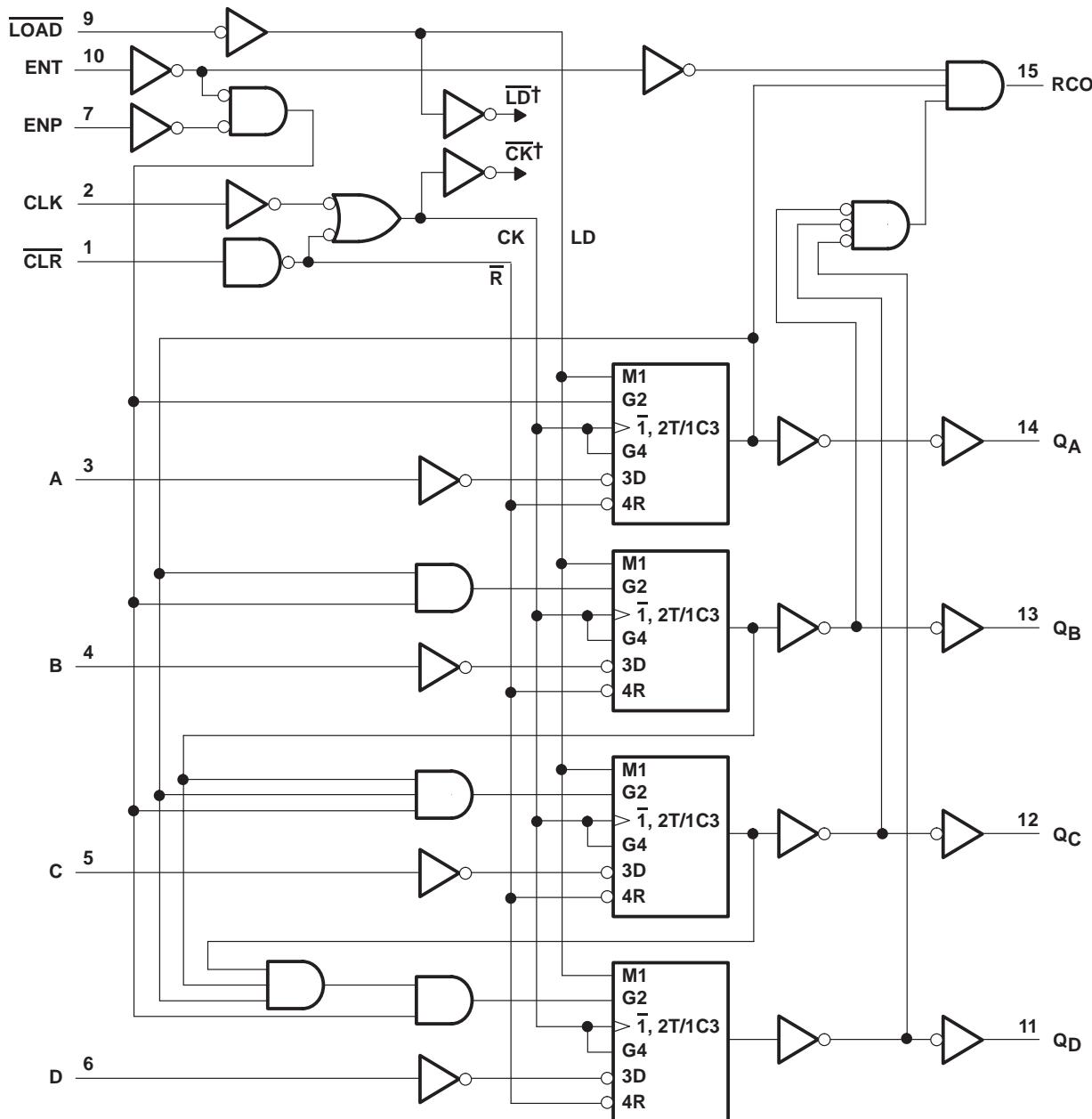
These counters feature a fully independent clock circuit. Changes at control inputs (ENP, ENT, or LOAD) that modify the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) is dictated solely by the conditions meeting the stable setup and hold times.

These devices are fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

FUNCTION TABLE

INPUTS					OUTPUTS				FUNCTION
CLR	LOAD	ENP	ENT	CLK	QA	QB	QC	QD	
L	X	X	X	X	L	L	L	L	Reset to "0"
H	L	X	X	↑	A	B	C	D	Preset Data
H	H	X	L	↑	No Change				No Count
H	H	L	X	↑	No Change				No Count
H	H	H	H	↑	Count up				Count
H	X	X	X	↑	No Change				No Count

logic diagram (positive logic)



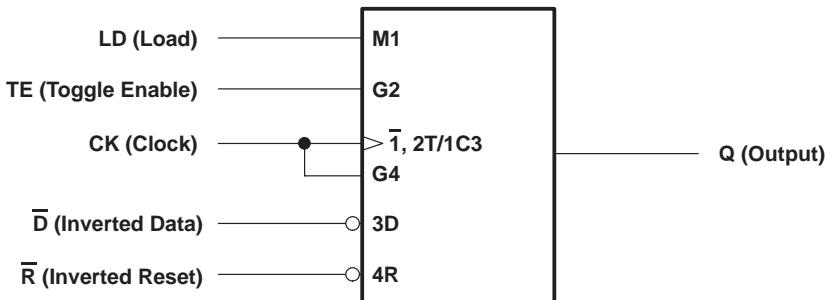
† For simplicity, routing of complementary signals  $\overline{LD}$  and  $\overline{CK}$  is not shown on this overall logic diagram. The uses of these signals are shown on the logic diagram of the D/T flip-flops.

Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

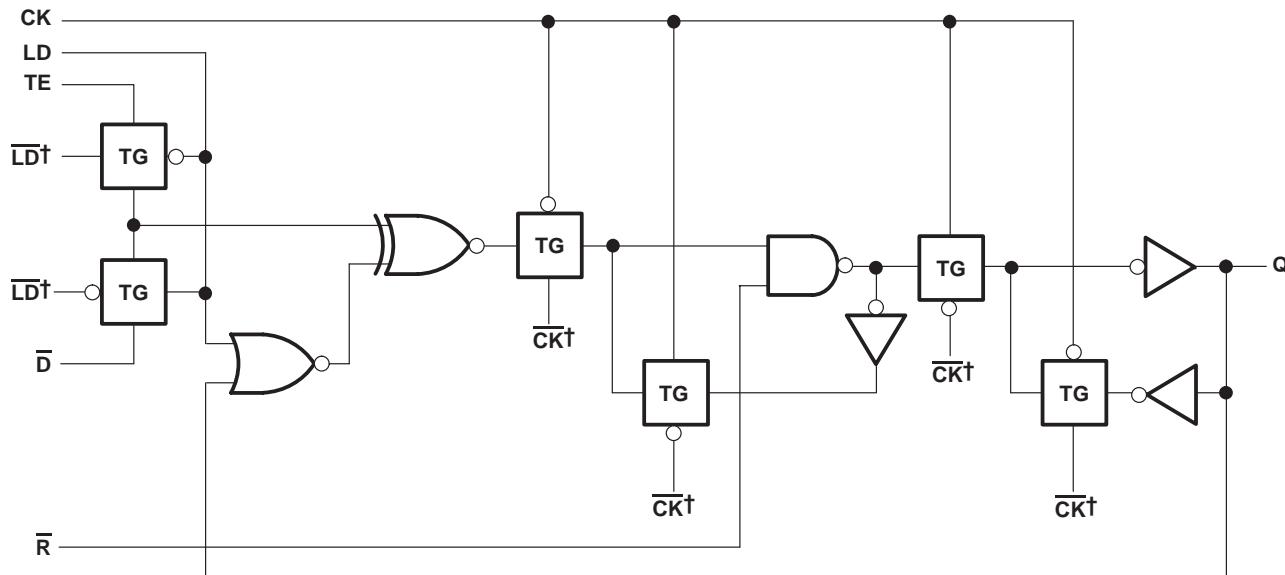
# SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

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logic symbol, each D/T flip-flop



logic diagram, each D/T flip-flop (positive logic)

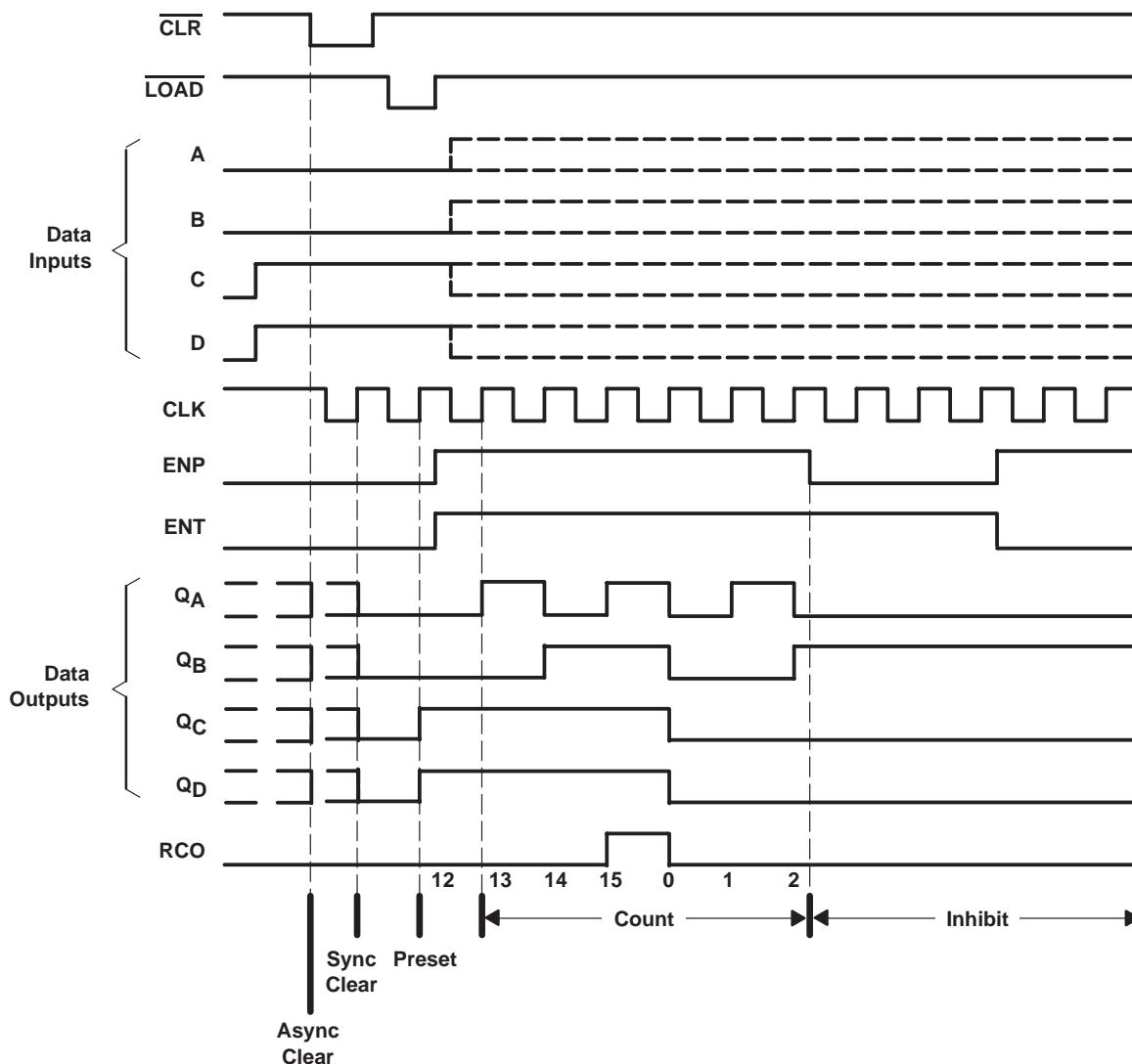


† The origins of  $\overline{LD}$  and  $\overline{CK}$  are shown in the overall logic diagram of the device.

**typical clear, preset, count, and inhibit sequence**

The following sequence is illustrated below:

1. Clear outputs to zero (asynchronous)
2. Preset to binary 12
3. Count to 13, 14, 15, 0, 1, and 2
4. Inhibit



# SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) .....	-0.5 V to 7 V
Output voltage range applied in high or low state, $V_O$ (see Notes 1 and 2) .....	-0.5 V to $V_{CC}$ + 0.5 V
Voltage range applied to any output in the power-off state, $V_O$ (see Note 1) .....	-0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....	-20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ ) .....	-50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....	$\pm 25$ mA
Continuous current through $V_{CC}$ or GND .....	$\pm 50$ mA
Package thermal impedance, $\theta_{JA}$ (see Note 3):	
D package .....	73°C/W
DB package .....	82°C/W
DGV package .....	120°C/W
NS package .....	64°C/W
PW package .....	108°C/W
Storage temperature range, $T_{stg}$ .....	-65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.  
2. This value is limited to 5.5 V maximum.  
3. The package thermal impedance is calculated in accordance with JESD 51-7.

# SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

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## recommended operating conditions (see Note 4)

			SN54LV161A	SN74LV161A	UNIT	
		MIN	MAX	MIN	MAX	
V <sub>CC</sub>	Supply voltage	2	5.5	2	5.5	V
V <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 2 V	1.5	1.5		V
		V <sub>CC</sub> = 2.3 V to 2.7 V	V <sub>CC</sub> × 0.7	V <sub>CC</sub> × 0.7		
		V <sub>CC</sub> = 3 V to 3.6 V	V <sub>CC</sub> × 0.7	V <sub>CC</sub> × 0.7		
		V <sub>CC</sub> = 4.5 V to 5.5 V	V <sub>CC</sub> × 0.7	V <sub>CC</sub> × 0.7		
V <sub>IL</sub>	Low-level input voltage	V <sub>CC</sub> = 2 V	0.5	0.5		V
		V <sub>CC</sub> = 2.3 V to 2.7 V	V <sub>CC</sub> × 0.3	V <sub>CC</sub> × 0.3		
		V <sub>CC</sub> = 3 V to 3.6 V	V <sub>CC</sub> × 0.3	V <sub>CC</sub> × 0.3		
		V <sub>CC</sub> = 4.5 V to 5.5 V	V <sub>CC</sub> × 0.3	V <sub>CC</sub> × 0.3		
V <sub>I</sub>	Input voltage	0	5.5	0	5.5	V
V <sub>O</sub>	Output voltage	0	V <sub>CC</sub>	0	V <sub>CC</sub>	V
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 2 V	-50	-50	μA	mA
		V <sub>CC</sub> = 2.3 V to 2.7 V	-2	-2		
		V <sub>CC</sub> = 3 V to 3.6 V	-6	-6		
		V <sub>CC</sub> = 4.5 V to 5.5 V	-12	-12		
I <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 2 V	50	50	μA	mA
		V <sub>CC</sub> = 2.3 V to 2.7 V	2	2		
		V <sub>CC</sub> = 3 V to 3.6 V	6	6		
		V <sub>CC</sub> = 4.5 V to 5.5 V	12	12		
Δt/Δv	Input transition rise or fall rate	V <sub>CC</sub> = 2.3 V to 2.7 V	0	200	0	ns/V
		V <sub>CC</sub> = 3 V to 3.6 V	0	100	0	
		V <sub>CC</sub> = 4.5 V to 5.5 V	0	20	0	
T <sub>A</sub>	Operating free-air temperature	-55	125	-40	85	°C

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	SN54LV161A			SN74LV161A			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V <sub>OH</sub>	I <sub>OH</sub> = -50 μA	2 V to 5.5 V	V <sub>CC</sub> - 0.1			V <sub>CC</sub> - 0.1			V
	I <sub>OH</sub> = -2 mA	2.3 V	2			2			
	I <sub>OH</sub> = -6 mA	3 V	2.48			2.48			
	I <sub>OH</sub> = -12 mA	4.5 V	3.8			3.8			
V <sub>OL</sub>	I <sub>OL</sub> = 50 μA	2 V to 5.5 V		0.1		0.1		0.1	V
	I <sub>OL</sub> = 2 mA	2.3 V		0.4		0.4		0.4	
	I <sub>OL</sub> = 6 mA	3 V		0.44		0.44		0.44	
	I <sub>OL</sub> = 12 mA	4.5 V		0.55		0.55		0.55	
I <sub>I</sub>	V <sub>I</sub> = 5.5 V or GND	0 to 5.5 V		±1		±1		±1	μA
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	5.5 V		20		20		20	μA
I <sub>off</sub>	V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V	0		5		5		5	μA
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V		1.8		1.8		1.8	pF

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



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# SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

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**timing requirements over recommended operating free-air temperature range,  $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (unless otherwise noted) (see Figure 1)**

		$T_A = 25^\circ\text{C}$	SN54LV161A		SN74LV161A		UNIT
			MIN	MAX	MIN	MAX	
$t_W$	Pulse duration	CLK high or low	7	7	7	7	ns
		CLR low	7	7	7	7	
$t_{SU}$	Setup time before $CLK^\uparrow$	CLR	4.5	4.5	4.5	4.5	ns
		Data (A, B, C, and D)	7.5	8.5	8.5	8.5	
		ENP, ENT	9.5	11	11	11	
		LOAD low	10	11.5	11.5	11.5	
$t_H$	Hold time, all synchronous inputs after $CLK^\uparrow$		1.5	1.5	1.5	1.5	ns

**timing requirements over recommended operating free-air temperature range,  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted) (see Figure 1)**

		$T_A = 25^\circ\text{C}$	SN54LV161A		SN74LV161A		UNIT
			MIN	MAX	MIN	MAX	
$t_W$	Pulse duration	CLK high or low	5	5	5	5	ns
		CLR low	5	5	5	5	
$t_{SU}$	Setup time before $CLK^\uparrow$	CLR	2.5	2.5	2.5	2.5	ns
		Data (A, B, C, and D)	5.5	6.5	6.5	6.5	
		ENP, ENT	7.5	9	9	9	
		LOAD low	8	9.5	9.5	9.5	
$t_H$	Hold time, all synchronous inputs after $CLK^\uparrow$		1	1	1	1	ns

**timing requirements over recommended operating free-air temperature range,  $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$  (unless otherwise noted) (see Figure 1)**

		$T_A = 25^\circ\text{C}$	SN54LV161A		SN74LV161A		UNIT
			MIN	MAX	MIN	MAX	
$t_W$	Pulse duration	CLK high or low	5	5	5	5	ns
		CLR low	5	5	5	5	
$t_{SU}$	Setup time before $CLK^\uparrow$	CLR	1.5	1.5	1.5	1.5	ns
		Data (A, B, C, and D)	4.5	4.5	4.5	4.5	
		ENP, ENT	5	6	6	6	
		LOAD low	5	6	6	6	
$t_H$	Hold time, all synchronous inputs after $CLK^\uparrow$		1	1	1	1	ns

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**SN54LV161A, SN74LV161A**  
**4-BIT SYNCHRONOUS BINARY COUNTERS**

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**switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV161A		SN74LV161A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\text{max}}$			$C_L = 15 \text{ pF}$	50*	125*		40*		40		MHz
			$C_L = 50 \text{ pF}$	30	95		25		25		
$t_{\text{pd}}$	CLK	Q	$C_L = 15 \text{ pF}$	7.9*	16.2*		1*	19.5*	1	19.5	ns
		RCO (count mode)		8.9*	17*		1*	20.5*	1	20.5	
		RCO (preset mode)		11.9*	20.6*		1*	24.5*	1	24.5	
	ENT	RCO		8.3*	15.7*		1*	19*	1	19	
$t_{\text{PHL}}$	$\overline{\text{CLR}}$	Q	$C_L = 50 \text{ pF}$	8.8*	17*		1*	20.5*	1	20.5	ns
		RCO		9.8*	16.6*		1*	20*	1	20	
$t_{\text{pd}}$	CLK	Q	$C_L = 50 \text{ pF}$	10.5	19.2		1	22.5	1	22.5	ns
		RCO (count mode)		11.7	20		1	23.5	1	23.5	
		RCO (preset mode)		14.5	23.6		1	27.5	1	27.5	
	ENT	RCO		11	18.7		1	22	1	22	
$t_{\text{PHL}}$	$\overline{\text{CLR}}$	Q	$C_L = 50 \text{ pF}$	11.4	20		1	23.5	1	23.5	ns
		RCO		12.6	19.6		1	23	1	23	

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

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# SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV161A	SN74LV161A	UNIT
				MIN	TYP	MAX	MIN	MAX	
$f_{\text{max}}$			$C_L = 15 \text{ pF}^*$	80*	165*		70*	70	MHz
			$C_L = 50 \text{ pF}$	55	125		50	50	
$t_{\text{pd}}^*$	CLK	Q	$C_L = 15 \text{ pF}$	6	12.8		1*	15*	1 ns
		RCO (count mode)		6.7	13.6		1*	16*	16
		RCO (preset mode)		8.6	17.2		1*	20*	20
	ENT	RCO		6.2	12.3		1*	14.5*	14.5
$t_{\text{PHL}}^*$	$\overline{\text{CLR}}$	Q	$C_L = 50 \text{ pF}$	6.5	13.6		1*	16*	16
		RCO		7.2	13.2		1*	15.5*	15.5
$t_{\text{pd}}$	CLK	Q		7.8	16.3		1	18.5	ns
		RCO (count mode)		8.7	17.1		1	19.5	
		RCO (preset mode)		10.6	20.7		1	23.5	
	ENT	RCO		8.3	15.8		1	18	
$t_{\text{PHL}}$	$\overline{\text{CLR}}$	Q	$C_L = 50 \text{ pF}$	8.4	17.1		1	19.5	19.5
		RCO		9.2	16.7		1	19	19

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV161A		SN74LV161A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\text{max}}$			$C_L = 15 \text{ pF}$	135*	220		115*		115		MHz
			$C_L = 50 \text{ pF}$	95	165		85		85		
$t_{\text{pd}}$	CLK	Q	$C_L = 15 \text{ pF}$	4.5*	8.1*		1*	9.5*	1	9.5	ns
		RCO (count mode)		5.1*	8.1*		1*	9.5*	1	9.5	
		RCO (preset mode)		6.3*	10.3*		1*	12*	1	12	
	ENT	RCO		4.8*	8.1*		1*	9.5*	1	9.5	
$t_{\text{PHL}}$	$\overline{\text{CLR}}$	Q	$C_L = 50 \text{ pF}$	4.9*	9*		1*	10.5*	1	10.5	ns
		RCO		5.5*	8.6*		1*	10*	1	10	
$t_{\text{pd}}$	CLK	Q		5.9	10.1		1	11.5	1	11.5	ns
		RCO (count mode)		6.6	10.1		1	11.5	1	11.5	
		RCO (preset mode)		7.8	12.3		1	14	1	14	
	ENT	RCO		6.1	10.1		1	11.5	1	11.5	
$t_{\text{PHL}}$	$\overline{\text{CLR}}$	Q		6.3	11		1	12.5	1	12.5	
		RCO		6.9	10.6		1	12	1	12	

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics,  $V_{CC} = 3.3 \text{ V}$ ,  $C_L = 50 \text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (see Note 5)

PARAMETER	SN74LV161A			UNIT
	MIN	TYP	MAX	
$V_{OL(P)}$ Quiet output, maximum dynamic $V_{OL}$		0.3	0.8	V
$V_{OL(V)}$ Quiet output, minimum dynamic $V_{OL}$		-0.2	-0.8	V
$V_{OH(V)}$ Quiet output, minimum dynamic $V_{OH}$		3		V
$V_{IH(D)}$ High-level dynamic input voltage		2.31		V
$V_{IL(D)}$ Low-level dynamic input voltage		0.99		V

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics,  $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	$V_{CC}$	TYP	UNIT
$C_{\text{pd}}$ Power dissipation capacitance	$C_L = 50 \text{ pF}$ , $f = 10 \text{ MHz}$	3.3 V	23.6	pF
		5 V	25.8	

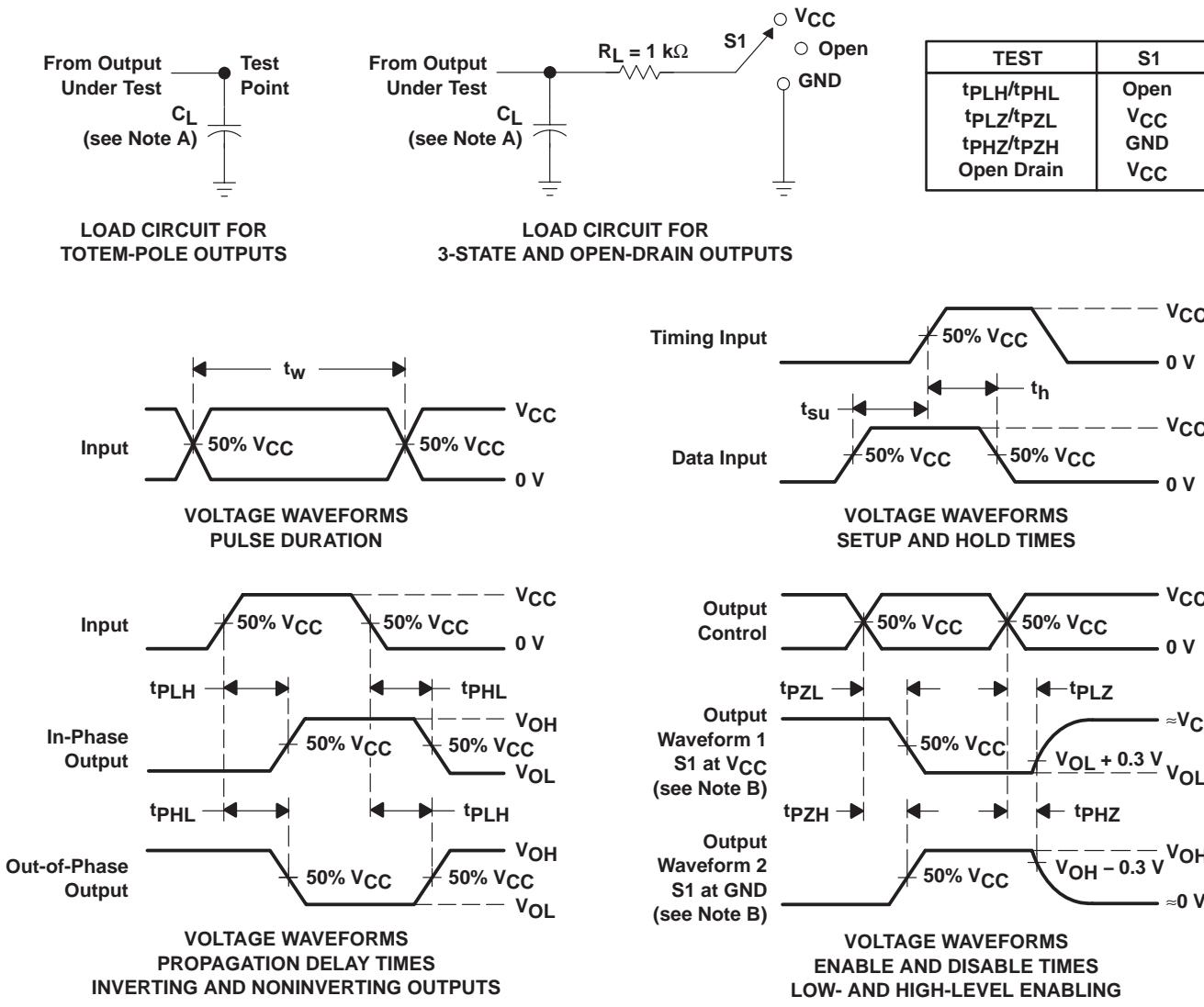
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# SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

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## PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 1$  MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq 3$  ns,  $t_r \leq 3$  ns.  
 D. The outputs are measured one at a time, with one input transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .  
 H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">SN74LV161AD</a>	Obsolete	Production	SOIC (D)   16	-	-	Call TI	Call TI	-40 to 85	LV161A
<a href="#">SN74LV161ADBR</a>	Active	Production	SSOP (DB)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ADBR.A	Active	Production	SSOP (DB)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
<a href="#">SN74LV161ADGVR</a>	Active	Production	TVSOP (DGV)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ADGVR.A	Active	Production	TVSOP (DGV)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
<a href="#">SN74LV161ADR</a>	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ADR.A	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
<a href="#">SN74LV161ANSR</a>	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	74LV161A
SN74LV161ANSR.A	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	74LV161A
<a href="#">SN74LV161APW</a>	Obsolete	Production	TSSOP (PW)   16	-	-	Call TI	Call TI	-40 to 85	LV161A
<a href="#">SN74LV161APWR</a>	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWR.A	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
<a href="#">SN74LV161APWRG4</a>	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	No	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
<a href="#">SN74LV161APWRG4</a>	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWRG4.A	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWRG4.A	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	No	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
<a href="#">SN74LV161APWT</a>	Obsolete	Production	TSSOP (PW)   16	-	-	Call TI	Call TI	-40 to 85	LV161A

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

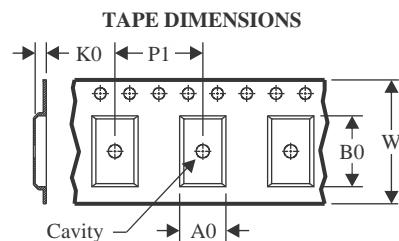
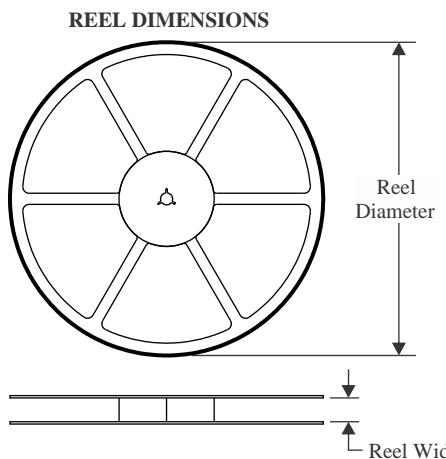
<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

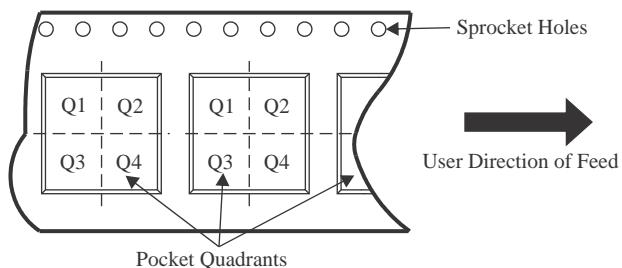
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

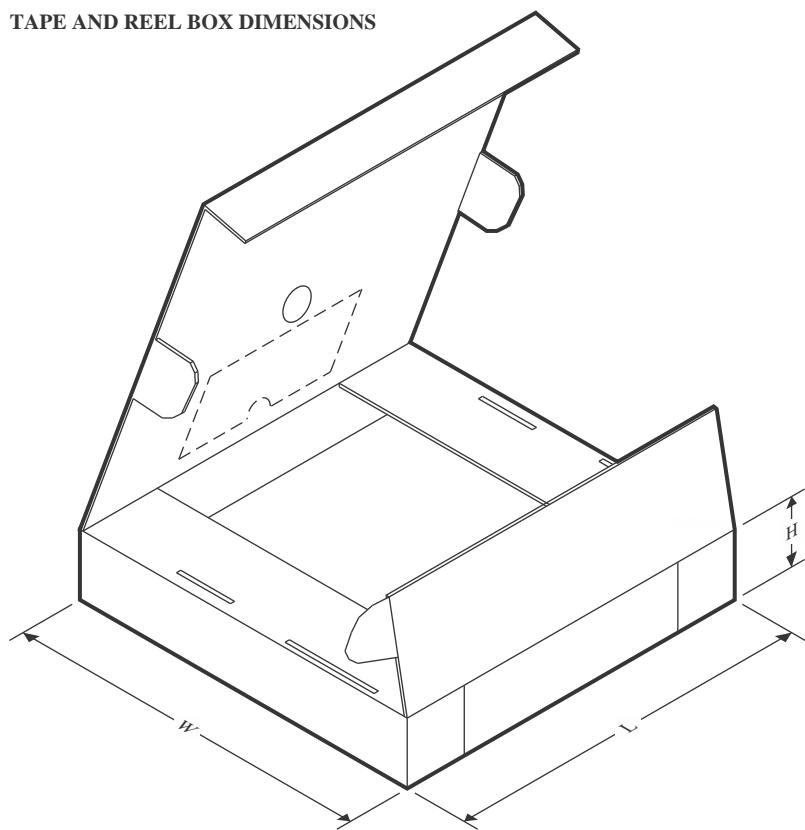
**TAPE AND REEL INFORMATION**


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LV161ADBR	SSOP	DB	16	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
SN74LV161ADGVR	TVSOP	DGV	16	2000	330.0	12.4	6.8	4.0	1.6	8.0	12.0	Q1
SN74LV161ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LV161ANSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
SN74LV161APWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LV161APWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

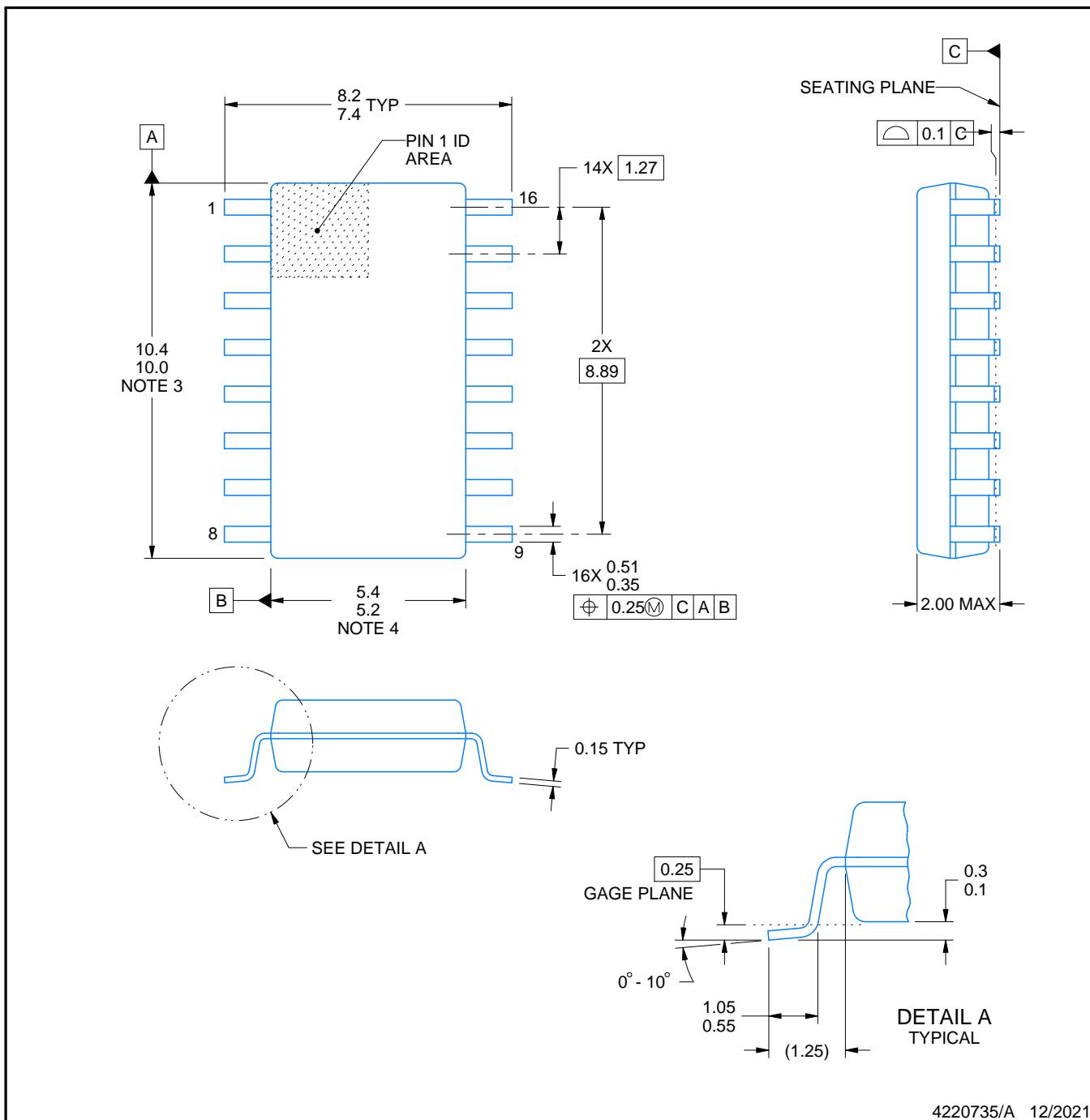
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LV161ADBR	SSOP	DB	16	2000	353.0	353.0	32.0
SN74LV161ADGVR	TVSOP	DGV	16	2000	353.0	353.0	32.0
SN74LV161ADR	SOIC	D	16	2500	353.0	353.0	32.0
SN74LV161ANSR	SOP	NS	16	2000	353.0	353.0	32.0
SN74LV161APWR	TSSOP	PW	16	2000	353.0	353.0	32.0
SN74LV161APWRG4	TSSOP	PW	16	2000	353.0	353.0	32.0



# PACKAGE OUTLINE

## SOP - 2.00 mm max height

SOP



### NOTES:

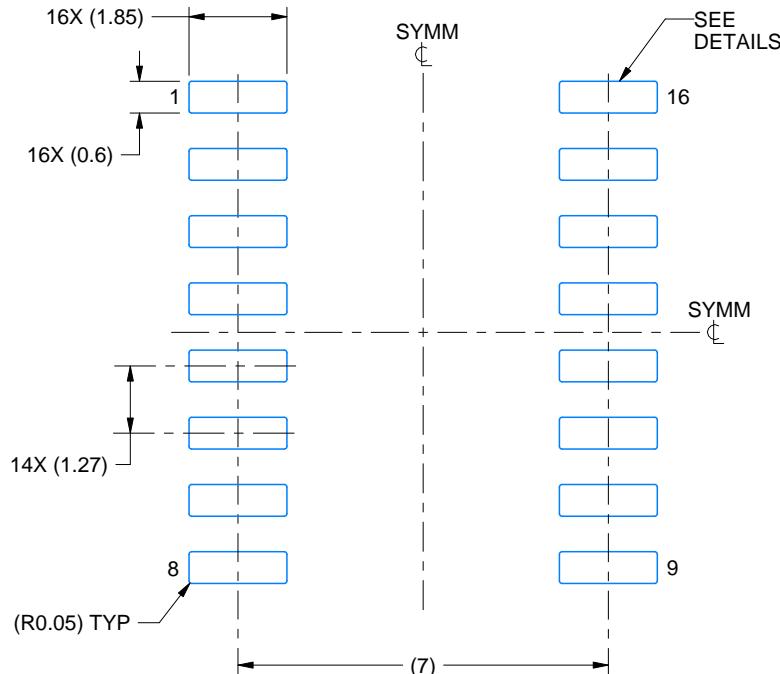
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

# EXAMPLE BOARD LAYOUT

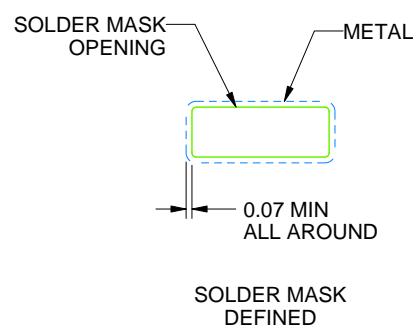
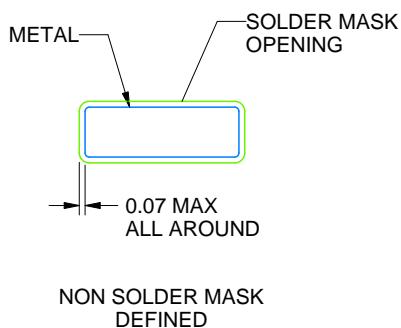
NS0016A

SOP - 2.00 mm max height

SOP



LAND PATTERN EXAMPLE  
SCALE:7X



SOLDER MASK DETAILS

4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

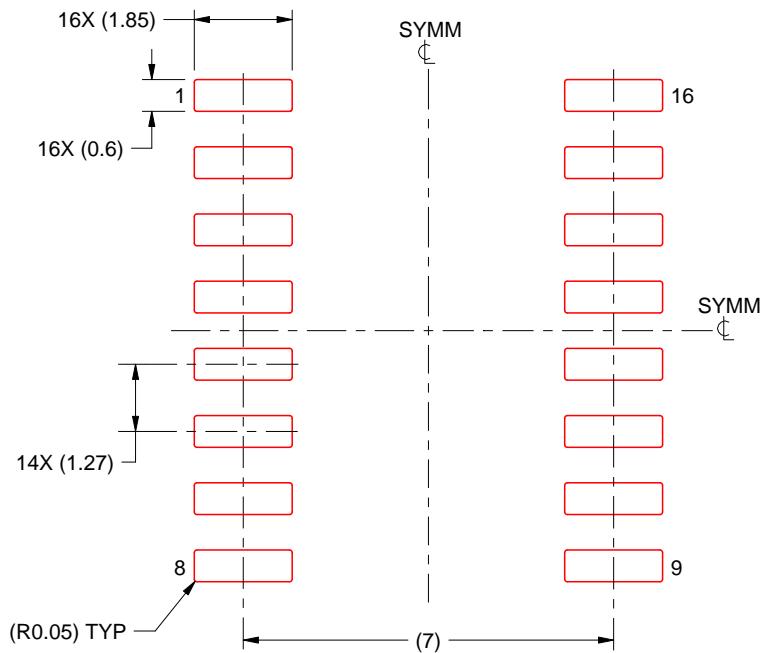
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:7X

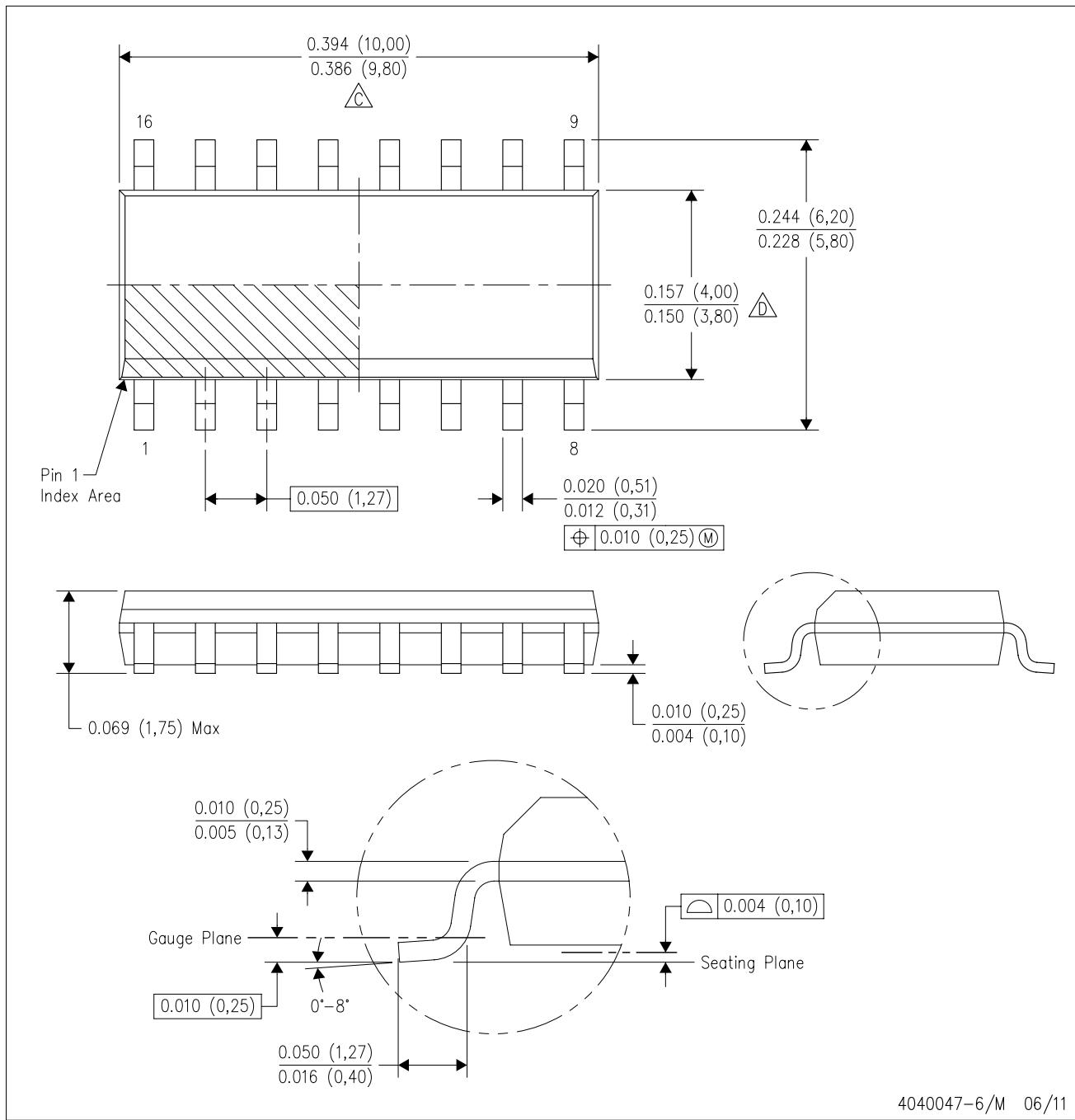
4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.

D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.

E. Reference JEDEC MS-012 variation AC.

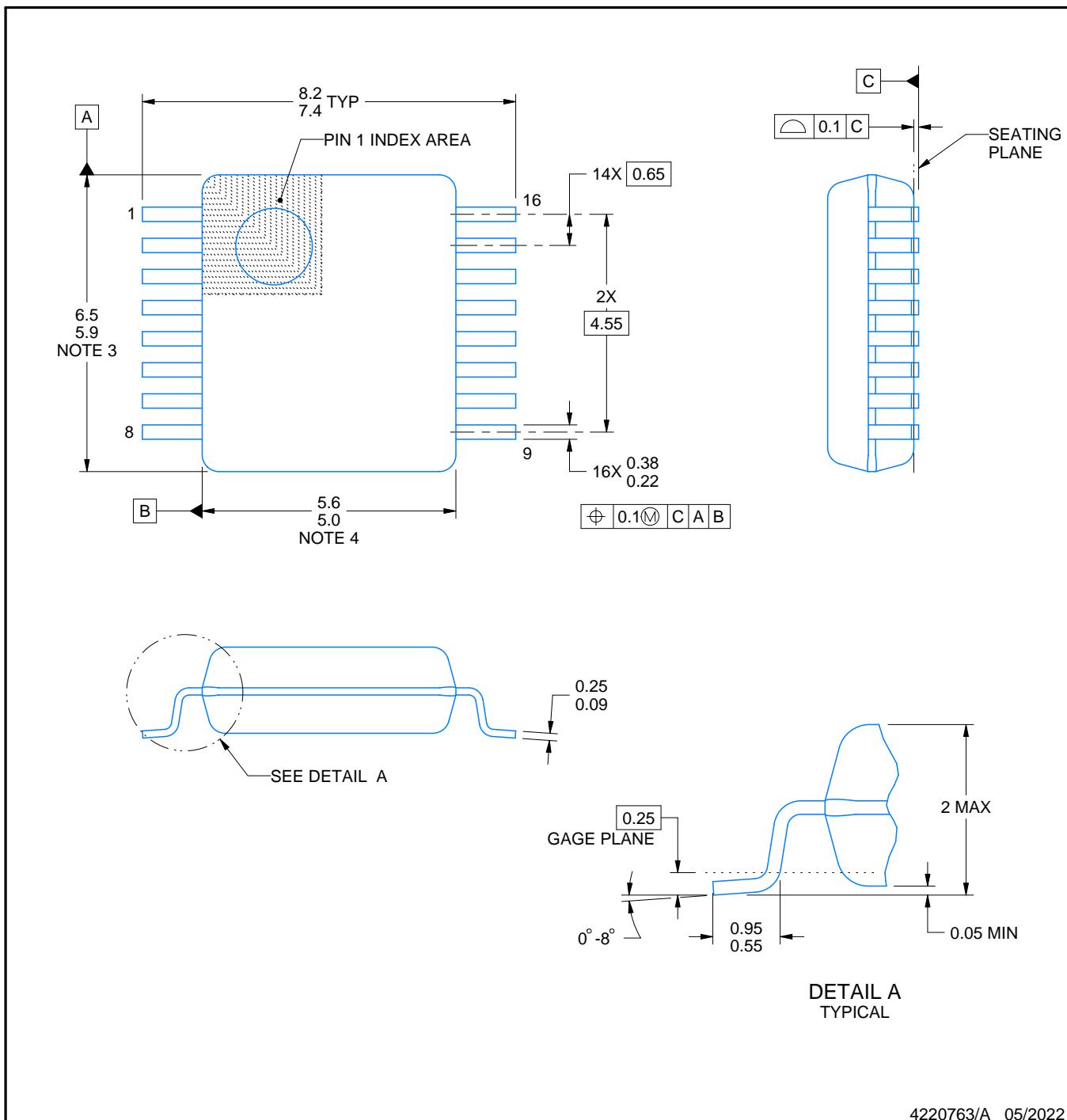
# PACKAGE OUTLINE

DB0016A



SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

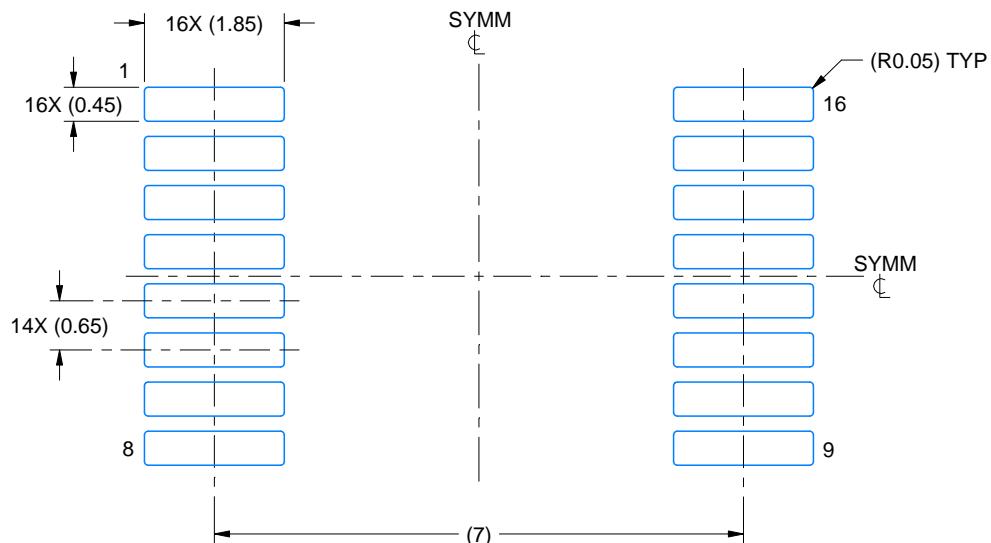
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-150.

# EXAMPLE BOARD LAYOUT

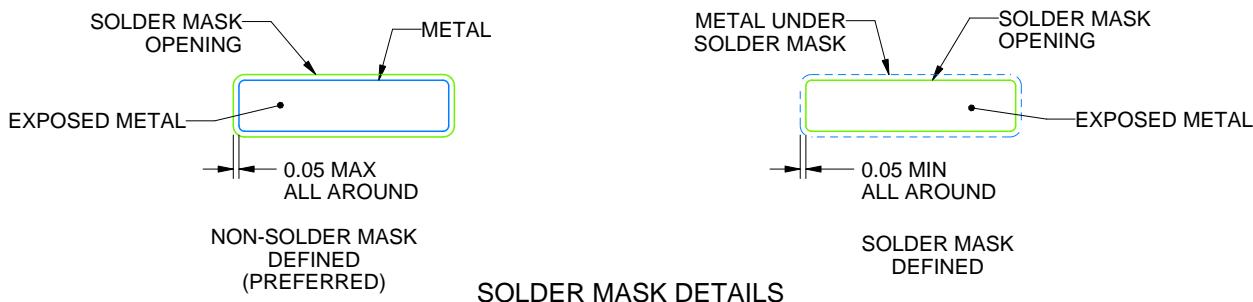
DB0016A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220763/A 05/2022

NOTES: (continued)

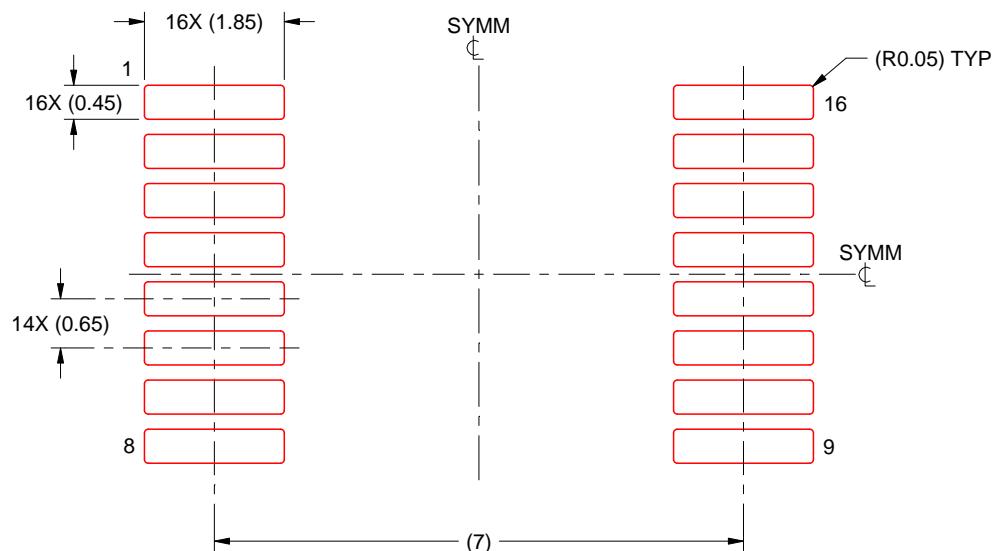
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

**DB0016A**

## SSOP - 2 mm max height

## SMALL OUTLINE PACKAGE



**SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X**

4220763/A 05/2022

#### NOTES: (continued)

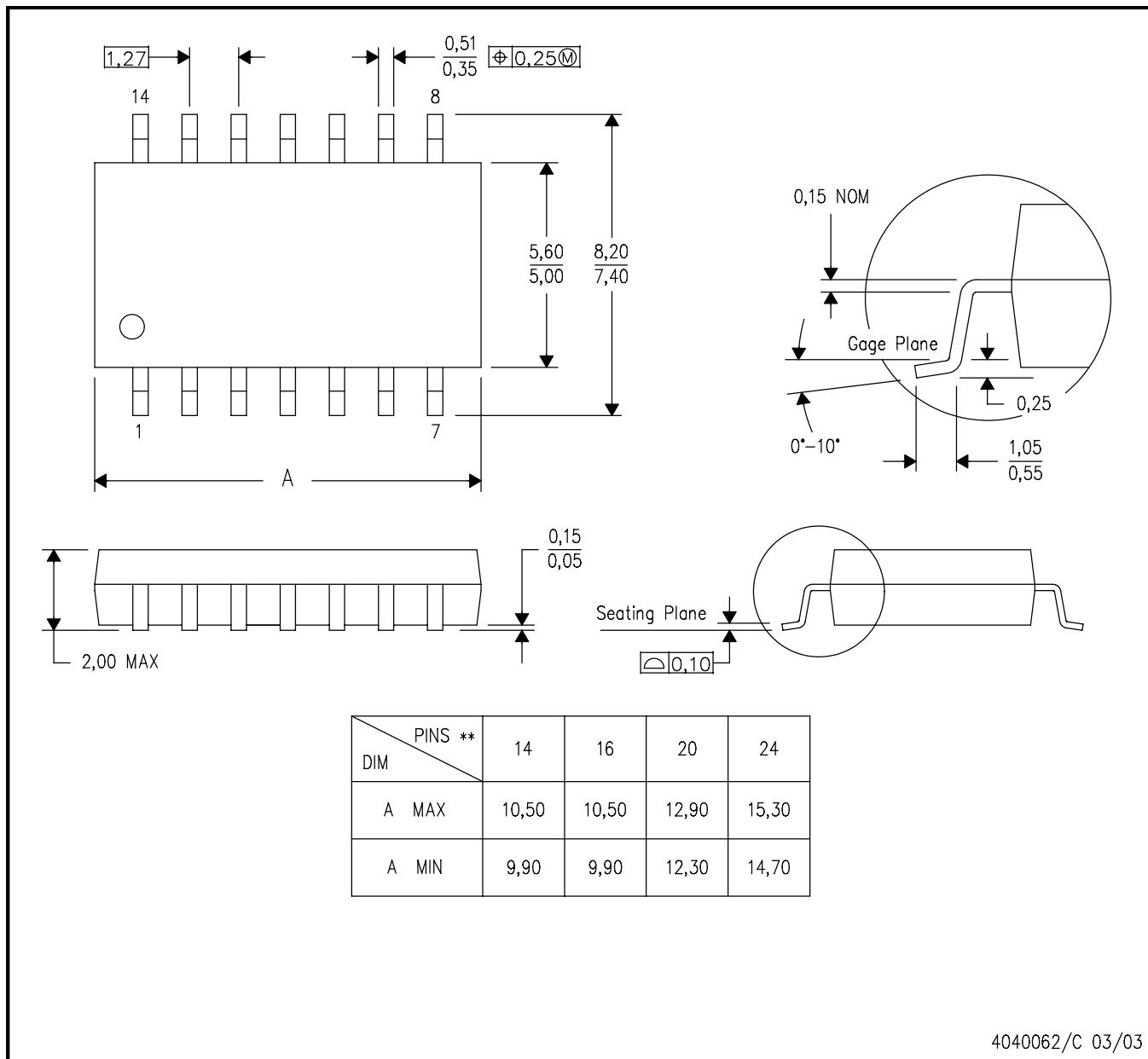
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## MECHANICAL DATA

**NS (R-PDSO-G\*\*)**

## PLASTIC SMALL-OUTLINE PACKAGE

**14-PINS SHOWN**



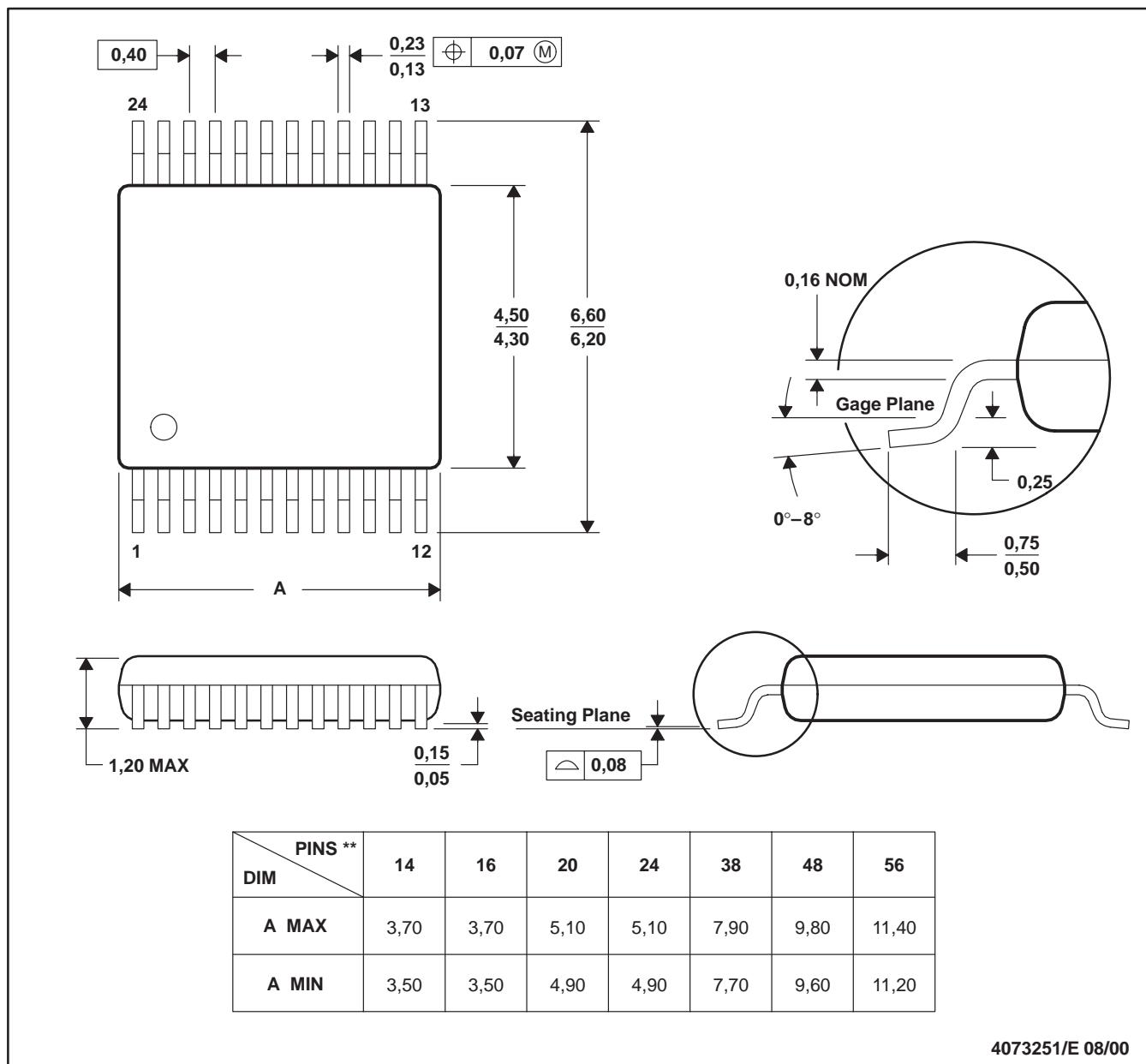
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

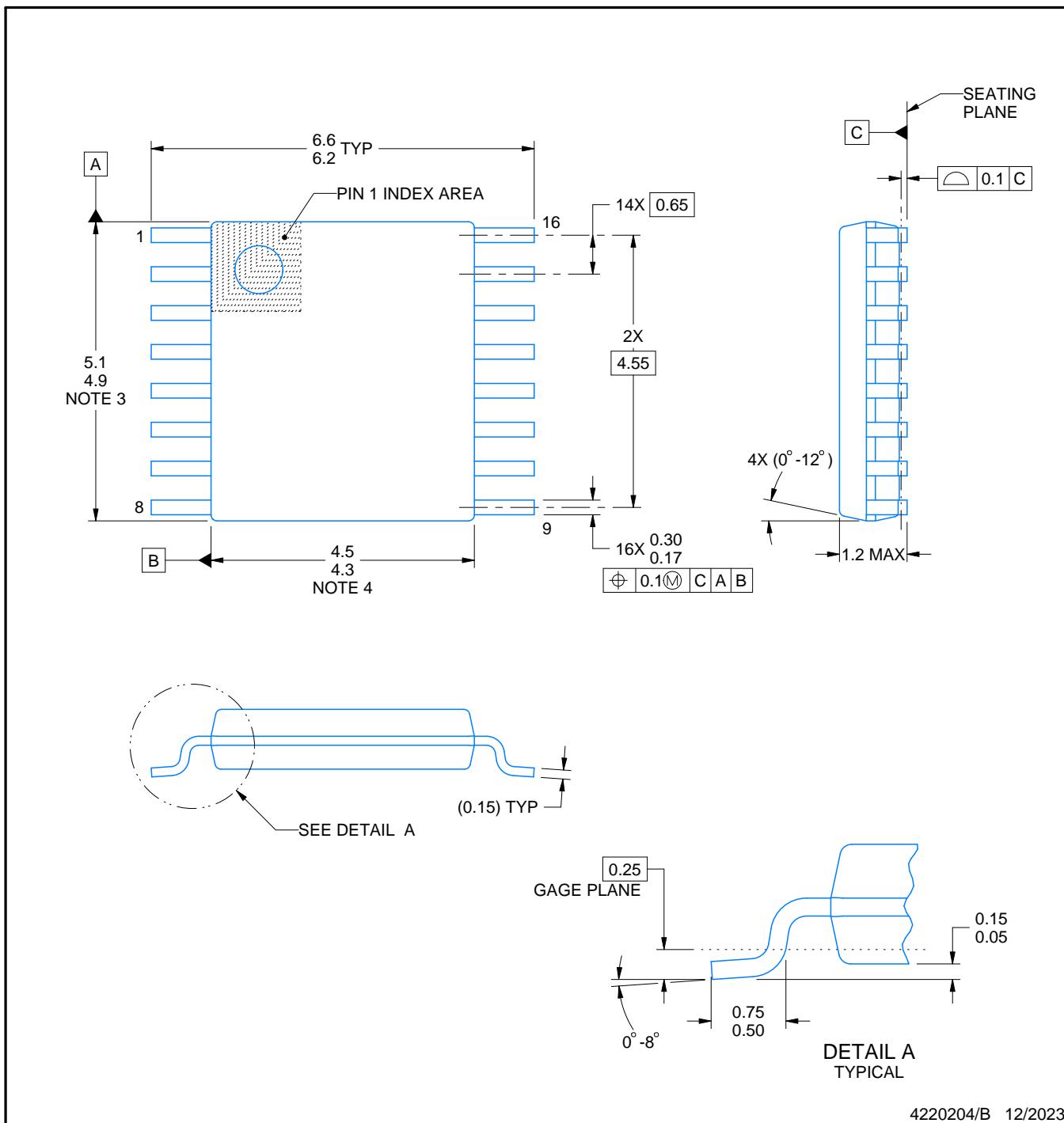
# PACKAGE OUTLINE

PW0016A



TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



## NOTES:

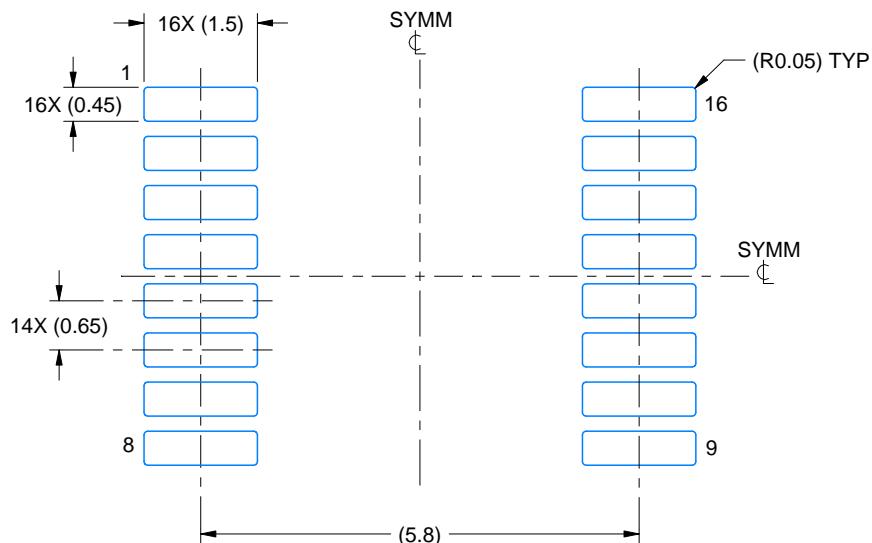
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

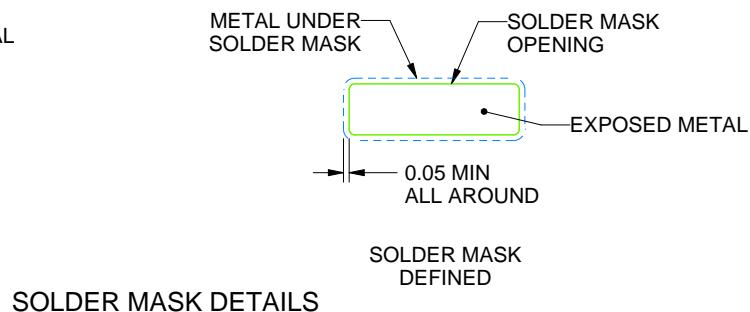
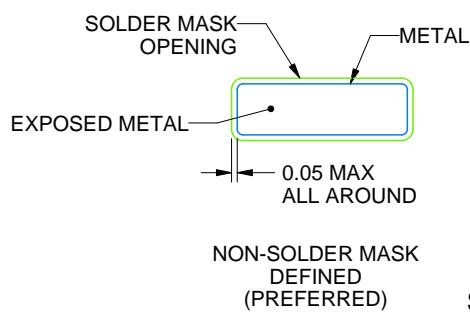
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220204/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

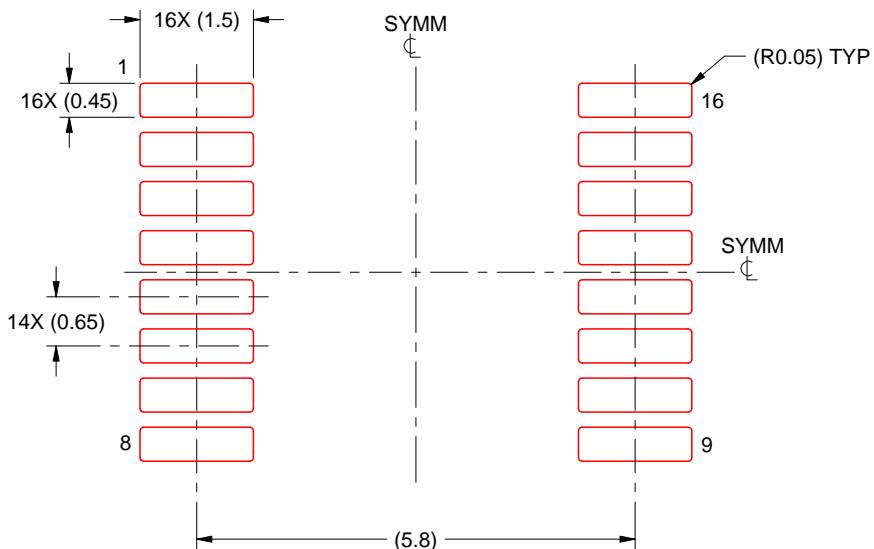
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220204/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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